## **AMENDMENTS TO THE CLAIMS**

Please amend claim 16 and add new claims 20-24 as shown in the following Listing of Claims. This Listing of Claims replaces all prior versions, and listings, of claims in the present application.

## **Listing of Claims**

1. (Withdrawn) A method of making an optical regent format with a capillary gap, comprising:

providing a carrier with an insert, said carrier and insert being of a predetermined thickness;

placing said carrier in a mold;

molding a format onto said carrier and insert;

separating said insert from said carrier; and

removing said insert from said format leaving a capillary gap in said format.

- 2. (Withdrawn) The method of making an optical reagent format claimed in claim 1 further comprising applying reagent in said capillary gap.
- 3. (Withdrawn) The method of making an optical reagent format claimed in claim 1 said capillary gap having open sides, and sealing said open sides of said capillary gap.
- 4. (Withdrawn) The method of making an optical reagent format claimed in claim 1 further comprising removing said format from said carrier.
- 5. (Withdrawn) The method of making an optical reagent format claimed in claim 1 providing a plurality of carriers joined together and each including an insert, and molding a format onto each of said plurality of carriers and inserts.
- 6. (Withdrawn) The method of making an optical reagent format claimed in claim 1 said format including a pair of legs, further comprising forming said capillary gap between a pair of legs of said format.

- 7. (Withdrawn) The method of making an optical reagent format claimed in claim 1 wherein molding said format comprises molding a first format on an upper surface of said carrier and molding a second format on a lower surface of said carrier.
- 8. (Withdrawn) The method of making an optical reagent format claimed in claim 7 wherein said first and second formats are of a conical configuration.
- 9. (Withdrawn) A method of making an optical reagent format with a capillary gap, comprising:

providing a carrier of a predetermined thickness;

providing an insert on said carrier;

molding a format onto said carrier and said insert with a portion of said insert extending out of said format; and

removing said insert from said format to provide a capillary channel with an inlet and a vent in said format formed by said insert.

- 10. (Withdrawn) The method of making an optical reagent format claimed in claim 9 comprising removing said carrier from said format.
- 11. (Withdrawn) The method of making an optical reagent format claimed in claim 9 said insert comprising a material of a melt temperature higher than the melt temperature of the material of said format.
- 12. (Withdrawn) The method of making an optical reagent format claimed in claim 9 comprising molding said format with a first leg for the application of a light source and a second leg for the application of a light detector, said capillary channel being between said first and second legs.
- 13. (Withdrawn) The method of making an optical reagent format claimed in claim 9 comprising molding said format with a first conical member on a first side of said format and a

MSE #2616 CHICAGO 283029v1 47082-00019 second conical member on a second side of said format with said capillary channel between said first conical member and said second conical member.

14. (Withdrawn) A method of molding an electrochemical sensor using a sacrificial insert, comprising:

providing a first mold;

inserting a first electrical contact in said first mold;

inserting a second electrical contact in said first mold;

closing said first mold with a second mold;

injecting material for forming a sensor into said closed first and second molds;

curing said material; and

extracting said sacrificial insert from said sensor.

- 15. (Withdrawn) The method of molding an electrochemical sensor claimed in claim 14 wherein extracting said sacrificial insert includes clamping said insert and moving said sensor relative to said insert.
  - 16. (Currently Amended) An electrochemical sensor, comprising:
  - a sensor base;
  - a sacrificial insert on said sensor base;
- a first electrical contact and a second electrical contact in said sensor, said sacrificial insert positioned between said first electrical contact and said second electrical contact; and

plastic material on said sensor base and over said sacrificial insert, said plastic material of a formulation which allows removal of said sacrificial insert from said plastic material and said sensor base leaving a capillary channel in said easting plastic material.

- 17. (Withdrawn) A tool for extracting a sacrificial insert from an electrochemical sensor, comprising:
  - a clamp for clamping a sacrificial insert in a stationary position;
  - a first block moveable relative to said clamp;
  - a drive member for moving said block relative to said clamp; and

an attachment member on said block to attach a sensor with a sacrificial insert onto said block.

- 18. (Withdrawn) The tool claimed in claim 17 further comprising a base, said clamp including a second block secured to said base.
  - 19. (Withdrawn) A sensor, comprising:
  - a sensor body;
  - a first access window in said sensor body;
  - a second access window in said sensor body; and

an insert in said sensor body between said first access window and said second access window.

- 20. (New) The sensor of claim 16 wherein the sacrificial insert is constructed of metal.
- 21. (New) The sensor of claim 16 wherein the sacrificial insert is constructed of stainless steel.
- 22. (New) The sensor of claim 16 wherein the insert comprises a material having a melt temperature higher than the melt temperature of the plastic material.
- 23. (New) The sensor of claim 16 comprising a reagent disposed within the capillary channel.
- 24. (New) The sensor of claim 16 wherein the sensor is adapted to analyze a liquid sample.